

1

2

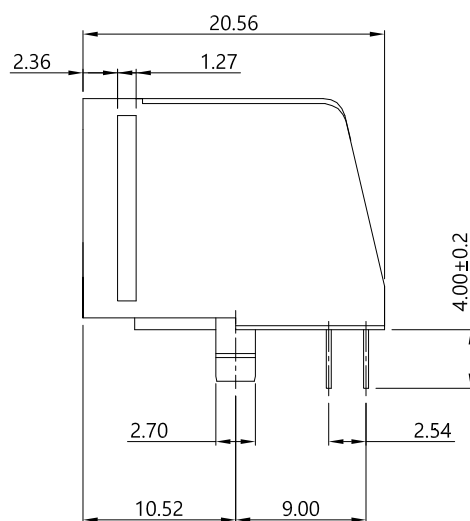
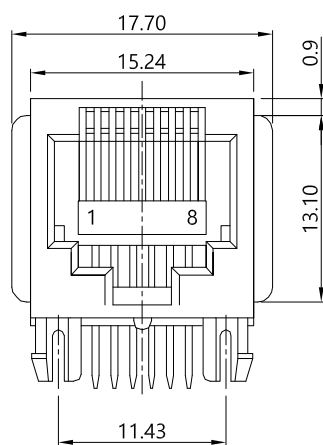
3

4

MARK

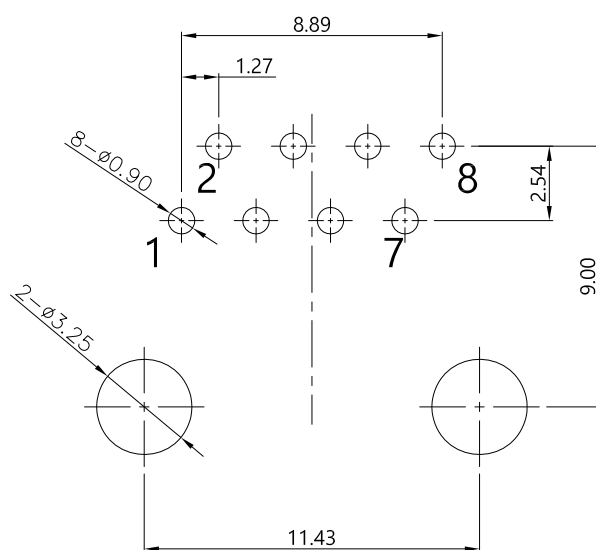
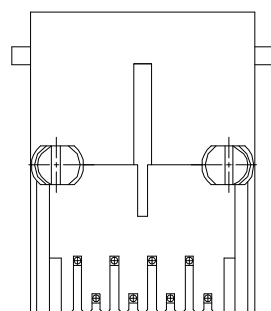
DESCRIPTION

A



A

B



B

C

Note.

1. Gold Plating Thickness Is 3 µin

Electrical

1. Voltage Rating : 125 VAC Rms

2. Current Rating: 1.5 AMP

3. Contact Resistance: 30 Milliohms MaX

4. Insulation Resistance: 500 megohms min @500V DC

5. Dielectric Withstanding: Resistance: 1000V AC Rms 60Hz. 1Min

6. Durability: 750 Cycles Min

7. Operation Temperature: -40°C ~ +85°C

C

PCB LAYOUT

D

2		CONTACT PLATE	PHOSPHOR BRONZE	T=0.35	Gold Plating Over Nickel	
1		HOUSING	PBT	COLOR : BLACK		UL 94V-0
NO	部 番 PART NO.	名 稱 TITLE	材 料 MATERIAL	規 格 SPECIFICATION	處 理 TREATMENT	備 考 REMARK
			三角法 THIRD ANGLE PROJECTION	單 位 UNIT mm INCH	尺 度 SCALE 1 / 1	提出先 USER
			承 認 APPROVAL	檢 圖 CHECK	設 計 DESIGN	圖 名 TITLE
						圖 番 Drawing No.
MARK	DATE	APPR	CHECK	DESIGN		

D

DEK 대은전자주식회사

DEK개발 007모 A4(06. 11. 21)

1

2

3

4